

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	314	((tube WITH (conduct\$5)) SAME solder\$3) AND ((\"600\"/\$) OR ("606"/\$) OR ("607"/\$)).ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 13:55
L2	180	((tube WITH (conduct\$5)) SAME (tube WITH solder\$3)) AND ((\"600\"/\$) OR ("606"/\$) OR ("607"/\$)).ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 13:57
L3	85	((tube NEAR8 (conduct\$5)) SAME (tube NEAR8 solder\$3)) AND ((\"600\"/\$) OR ("606"/\$) OR ("607"/\$)).ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 14:02
L4	18	((tube NEAR8 (conduct\$5)) SAME (tube NEAR8 solder\$3)) AND ((in ADJ vivo) OR invivo OR implant\$6 OR transcutaneou\$3 OR subcutaneou\$3 OR cutaneou\$3) AND ((\"600\"/\$) OR ("606"/\$) OR ("607"/\$)).ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 14:05
L5	18	((tube NEAR8 (conduct\$5)) SAME (tube NEAR8 solder\$3)) AND 4	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 14:05
L6	57	((tube NEAR8 solder\$3) SAME (wire OR lead)) AND ((in ADJ vivo) OR invivo OR implant\$6 OR transcutaneou\$3 OR subcutaneou\$3 OR cutaneou\$3) AND ((\"600\"/\$) OR ("606"/\$) OR ("607"/\$)).ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 14:13

L7	57	((tube NEAR8 solder \$3) SAME (wire OR lead)) AND 6	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 14:13
L8	0	((tube NEAR8 solder \$3 NEAR8 (circuit\$4 OR electronic OR substrate OR wafer OR semiconduct\$5)) AND (wire OR lead) AND ((in ADJ vivo) OR invivo OR implant \$6 OR transcutaneou \$3 OR subcutaneou \$3 OR cutaneou\$3) AND (("600"/\$) OR ("606"/\$) OR ("607"/\$)).cols.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 14:18
L9	8	((tube NEAR8 solder \$3 NEAR8 (circuit\$4 OR electronic OR substrate OR wafer OR semiconduct\$5)) AND (wire OR lead) AND ((in ADJ vivo) OR invivo OR implant \$6 OR transcutaneou \$3 OR subcutaneou \$3 OR cutaneou\$3)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 14:19
L10	8	((tube NEAR8 solder \$3 NEAR8 (circuit\$4 OR electronic OR substrate OR wafer OR semiconduct\$5)) AND 9	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 14:20
L11	24	((tube NEAR8 solder \$3) WITH (circuit\$4 OR electronic OR substrate OR wafer OR semiconduct\$5 OR electrode OR sensor OR detector)) AND (wire OR lead) AND ((in ADJ vivo) OR invivo OR implant \$6 OR transcutaneou \$3 OR subcutaneou \$3 OR cutaneou\$3)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 14:22

L12	24	((tube NEAR8 solder\$3) WITH (circuit\$4 OR electronic OR substrate OR wafer OR semiconduct\$5 OR electrode OR sensor OR detector)) AND 11	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 14:23
L27	14	(((tube OR cylinder) NEAR8 solder\$3) WITH (circuit\$4 OR electronic OR chip OR substrate OR wafer OR semiconduct\$5 OR electrode)) SAME (wire OR lead) AND ((in ADJ vivo) OR invivo OR implant\$6 OR transcutaneou\$3 OR subcutaneou\$3 OR cutaneou\$3)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 14:54
L28	14	((((tube OR cylinder) NEAR8 solder\$3) WITH (circuit\$4 OR electronic OR chip OR substrate OR wafer OR semiconduct\$5 OR electrode)) SAME (wire OR lead) AND ((in ADJ vivo) OR invivo OR implant\$6 OR transcutaneou\$3 OR subcutaneou\$3 OR cutaneou\$3))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 14:57
L29	14	((((tube OR cylinder) NEAR8 solder\$3) WITH (circuit\$4 OR electronic OR chip OR substrate OR wafer OR semiconduct\$5 OR electrode)) SAME (wire OR lead)) AND 28	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 14:57
L30	757	((((tube OR cylinder) NEAR8 solder\$3) WITH (circuit\$4 OR electronic OR chip OR substrate OR wafer OR semiconduct\$5 OR electrode)) SAME (wire OR lead))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 15:00

L31	28	(((tube OR cylinder) NEAR8 solder\$3) WITH (circuit\$4 OR electronic OR chip OR substrate OR wafer OR semiconduct\$5 OR electrode)) SAME (wire OR lead) AND (("600"/\$) OR ("606"/\$) OR ("607"/\$)).ccls.	US-PGPUB; USPAT; USOOR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 15:00
L32	1151	(((tube OR cylinder) WITH (circuit\$4 OR electronic OR chip OR substrate OR wafer OR semiconduct\$5)) SAME (wire OR lead) AND (("600"/\$) OR ("606"/\$) OR ("607"/\$)).ccls.	US-PGPUB; USPAT; USOOR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 15:17
L33	84	(((tube OR cylinder) NEAR5 conduct\$5) WITH (circuit\$4 OR electronic OR chip OR substrate OR wafer OR semiconduct\$5)) SAME (wire OR lead) AND (("600"/\$) OR ("606"/\$) OR ("607"/\$)).ccls.	US-PGPUB; USPAT; USOOR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 15:18
L34	3	(((tube OR cylinder) NEAR5 (metal OR steel OR conduct\$5)) WITH solder\$3 WITH (circuit\$4 OR chip OR microchip OR semiconduct\$5)) AND (sensor WITH (pressure OR catheter OR (in ADJ vivo) OR invivo OR implant\$6 OR transcutaneou\$3 OR subcutaneou\$3 OR cutaneou\$3)) AND (("600"/\$) OR ("606"/\$) OR ("607"/\$)).ccls.	US-PGPUB; USPAT; USOOR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 15:31

L35	3	((tube OR cylinder) NEAR5 (metal OR steel OR conduct\$5)) WITH solder\$3 WITH (circuit\$4 OR chip OR microchip OR semiconduct\$5)) AND 34	US-PGPUB; USPAT; USOOR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 15:32
L36	11	((tube OR cylinder) NEAR5 (metal OR steel OR conduct\$5)) WITH solder\$3 WITH (circuit\$4 OR chip OR microchip OR semiconduct\$5)) AND (sensor WITH (pressure OR catheter OR (in ADJ vivo) OR invivo OR implant\$6 OR transcutaneou\$3 OR subcutaneou\$3 OR cutaneou\$3))	US-PGPUB; USPAT; USOOR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 15:33
L37	11	((tube OR cylinder) NEAR5 (metal OR steel OR conduct\$5)) WITH solder\$3 WITH (circuit\$4 OR chip OR microchip OR semiconduct\$5)) AND 36	US-PGPUB; USPAT; USOOR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 15:33
L38	6	((tube OR cylinder) NEAR5 (metal OR steel OR conduct\$5)) WITH solder\$3 WITH (circuit\$4 OR chip OR microchip OR semiconduct\$5)) AND ("600"/\$) OR ("606"/\$) OR ("607"/\$).ccls.	US-PGPUB; USPAT; USOOR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 15:36
L39	20	((tube OR cylinder) WITH solder\$3 WITH (circuit\$4 OR chip OR microchip OR semiconduct\$5)) AND ("600"/\$) OR ("606"/\$) OR ("607"/\$).ccls.	US-PGPUB; USPAT; USOOR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 15:38

L40	60	(((tube OR cylinder) WITH solder\$3) SAME (circuit\$4 OR chip OR microchip OR semiconduct\$5) SAME (lead OR wire OR conductor) AND (("600"/\$) OR ("606"/\$) OR ("607"/\$)).cls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 15:41
L41	147	(((tube OR cylinder) NEAR8 conduct\$5) WITH solder\$3 WITH (circuit\$4 OR chip OR microchip OR semiconduct\$5) SAME (lead OR wire OR conductor))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 15:54
L42	3	(US-20040152999-\$ or US-20030100839-\$).did. or (US-6712772-\$).did.	US-PGPUB; USPAT	OR	ON	2008/04/11 16:18
L43	3	hollow AND tube AND 42	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 16:19
L44	332	(((tube OR cylinder) NEAR8 conduct\$5) WITH (circuit\$4 OR chip OR microchip OR semiconduct\$5)) AND (sensor WITH (pressure OR catheter OR (in ADJ vivo) OR invivo OR implant\$6 OR transcutaneou\$3 OR subcutaneou\$3 OR cutaneou\$3))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 16:24
L45	332	(((tube OR cylinder) NEAR8 conduct\$5) WITH (circuit\$4 OR chip OR microchip OR semiconduct\$5)) AND 44	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 16:25

L46	194	((tube OR cylinder) NEAR8 (conducting OR conductive\$2)) WITH (circuit\$4 OR chip OR microchip OR semiconduct\$5)) AND (sensor WITH (pressure OR catheter OR (in ADJ vivo) OR invivo OR implant\$6 OR transcutaneou\$3 OR subcutaneou\$3 OR cutaneou\$3))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 16:26
L47	194	((tube OR cylinder) NEAR8 (conducting OR conductive\$2)) WITH (circuit\$4 OR chip OR microchip OR semiconduct\$5)) AND 46	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 16:27
L48	12	("3778530" "4634638" "4970570" "5198885" "5329160" "5400489").PN. OR ("5508476").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/04/11 16:55
L49	2849	((circuit\$4 OR chip OR microchip OR semiconduct\$5) SAME sensor SAME (wire OR lead)) AND (sensor WITH pressure) AND (catheter OR (in ADJ vivo) OR invivo OR implant\$6 OR transcutaneou\$3 OR subcutaneou\$3 OR cutaneou\$3)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 16:58

L50	1170	((circuit\$4 OR chip OR microchip OR semiconduct\$5) SAME (sensor WITH pressure) SAME (wire OR lead)) AND (catheter OR (in ADJ vivo) OR invivo OR implant\$6 OR transcutaneou\$3 OR subcutaneou\$3 OR cutaneou\$3)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 16:59
L51	425	(((circuit\$4 OR chip OR microchip OR semiconduct\$5) WITH (sensor WITH pressure)) SAME (wire OR lead)) AND (catheter OR (in ADJ vivo) OR invivo OR implant\$6 OR transcutaneou\$3 OR subcutaneou\$3 OR cutaneou\$3) AND (("600"/\$) OR ("606"/\$) OR ("607"/\$)).cols.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 17:21
L52	191	(((circuit\$4 OR chip OR microchip OR semiconduct\$5) WITH (sensor WITH pressure)) SAME (wire OR lead)) AND (catheter OR (in ADJ vivo) OR invivo OR implant\$6 OR transcutaneou\$3 OR subcutaneou\$3 OR cutaneou\$3) AND (("600"/\$) OR ("606"/\$) OR ("607"/\$)).cols.	USPAT	OR	ON	2008/04/11 17:25
L53	191	(((circuit\$4 OR chip OR microchip OR semiconduct\$5) WITH (sensor WITH pressure)) SAME (wire OR lead)) AND 52	USPAT	OR	ON	2008/04/11 17:25

L54	21	({"2816997" "20020055764" "20060200200" "4407296" "4825876" "4873986" "5037488" "5094242" "5184619" "5211175" "5411538" "5522266" "5566680" "5658321" "5726624" "5969591" "5984711" "6006135" "6248083" "6712772" "6764472").PN.	US-PGPUB; USPAT	OR	OFF	2008/04/11 17:29
L55	206	({"2532507" "2549049" "3090377" "3418853" "3447378" "3545275" "3553625" "3565056" "3628526" "3746087" "3847483" "3946724" "4114604" "4202339" "4399820" "4407296" "4421386" "4444498" "4467807" "4523279" "4554927" "4566456" "4623248" "4651741" "4697593" "4708143" "4727879" "4730389" "4730622" "4750495" "4791935" "4807629"	US-PGPUB; USPAT; USOCR	OR	ON	2008/04/11 17:38

"4807632" |
"4813421" |
"4815469" |
"4827933" |
"4830488" |
"4877032" |
"4903701" |
"4967755" |
"5005573" |
"5005587" |
"5040538" |
"5052388" |
"5058586" |
"5067960" |
"5113862" |
"5113868" |
"5137019" |
"5176138" |
"5199428" |
"5267564" |
"5275171" |
"5312454" |
"5324326" |
"5329922" |
"5342406" |
"5358519" |
"5377524" |
"5411532" |
"5438987" |
"5490323" |
"5535752" |
"5556421" |
"5564434" |
"5593430" |
"5601611" |
"5730125" |
"5743267" |
"5755668" |
"5758652" |
"5788647" |
"5807265" |
"5836886" |
"B14467807" |
"H001114").PN. OR
(("3831588" |
"5324326" |
"6019729" |
"6125290" |
"6125291").URPN.

L56	9	(US-6125291-\$ or US-6125290-\$ or US-6019729-\$ or US-5324326-\$ or US-3831588-\$ or US-6915162-\$ or US-5836886-\$ or US-5807265-\$ or US-4730389-\$).did.	USPAT	OR	ON	2008/04/11 17:59
L57	4	56 AND semiconduct\$	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 18:00

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